



V01 1

ES-2835-1072V-L1-XXXX Datasheet

This 2835 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc

This part has a foot print that is compatible to most of the same size LED in the market today.



FEATURES

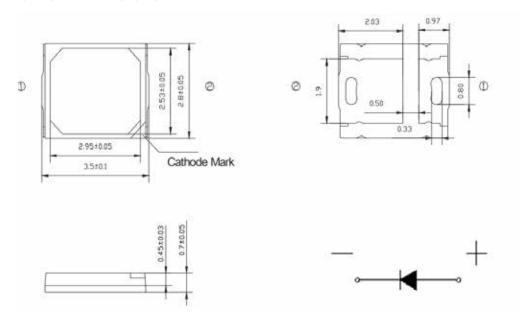
- Available in Cool White, Neutral White and Warm White color
- ANSI-compatible chromaticity bins
- High luminous Intensity and high efficiency
- Compatible with reflow soldering process
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- Silicone encapsulation
- Environmental friendly, RoHS compliance

APPLICATIONS

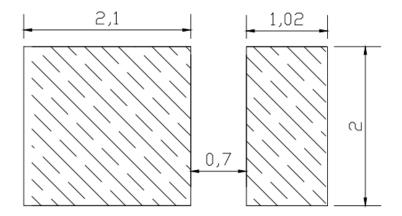
- Interior & exterior automotive lighting
- Decorative and landscape lighting
- Signage and channel letter
- Decorating and entertainment lighting
- Architectural lighting



PACKAGE DIMENSIONS



Recommended Solder Pad Design



- 1. All dimensions in millimeters.
- 2. Thickness tolerance of copper plate is ±0.02mm.
- 3. Thickness tolerance of product is ±0.05mm.
- 4. Tolerance is ±0.1mm unless otherwise noted.



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Forward current	lF	15	mA
Peak Forward Current	I FP	20	mA
Reverse Voltage	V_{R}	75	V
Power Dissipation	P_{d}	1128	mW
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	T_{stg}	-40~+100	°C
Soldering Temperature	T_{sld}	Reflow Soldering	: 260°C for 10
		seconds	
LED Junction Temperature	Tj	115	°C

I_{FP} Conditions: Pulse Width ≤10msec. and Duty ≤1/10.

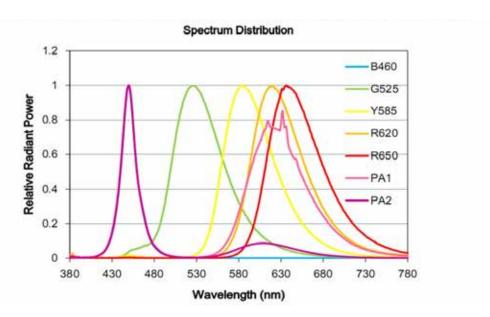
CHARACTERISTICS (Tj=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V_{F}	IF=15mA	64		72	V
Viewing Angle	201/2	IF=15mA		120		deg.
Luminous Flux	Фv	IF=15mA	20		225	lm
Thermal Resistance (Junction to Solder Point)	R _{th-js}	IF=15mA		15		°C/W

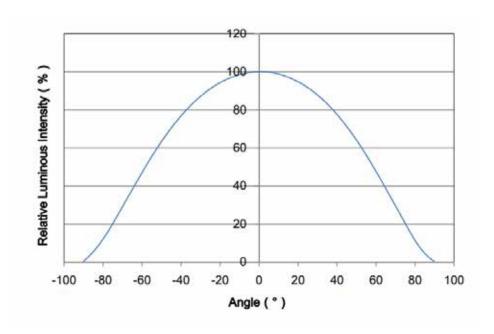
- 1. Luminous flux is measured with an accuracy of \pm 10%.
- 2. Chromaticity coordinate bins are measured with an accuracy of $\pm\,0.01$.
- 3. All measurements were made under the standardized environment of Everstar



RELATIVE SPECTRAL POWER DISTRIBUTION (Tj=25°C)

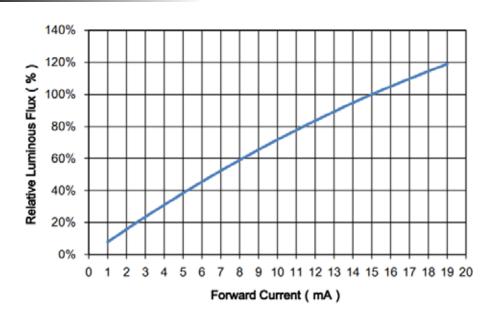


TYPICAL SPATIAL DISTRIBUTION

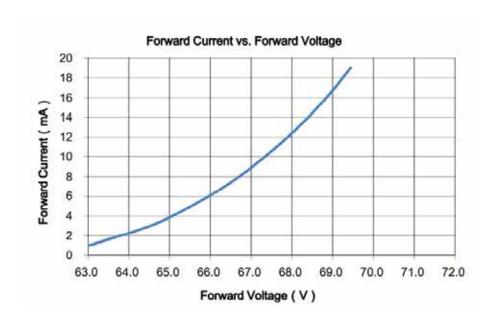




RELATIVE LUMINOUS FLUX VS. CURRENT (Tj=25°C)

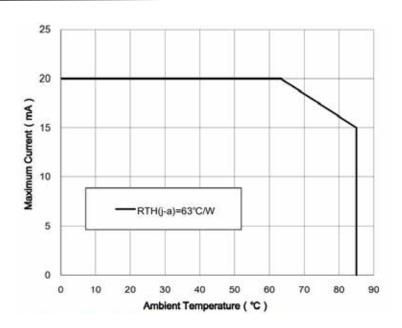


ELECTRICAL CHARACTERISTICS (Tj=25°C)

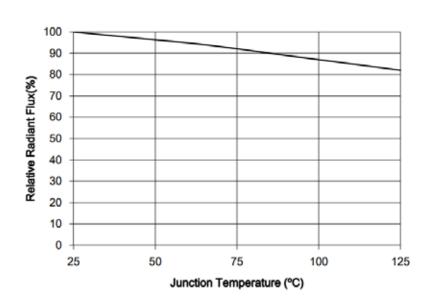




MAXIUM CURRENT VS. AMBIENT TEMPERATURE



RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE





SORTING RANKS

(1) Luminous Intensity ($Tj=25^{\circ}C$)

Part No.	Condition	Rank	Unit
ES-2835-1072V-L1-R637		O43 38-43	
ES-2835-1072V-L1-G525	-	R13 215-225	
ES-2835-1072V-L1-B460	15mA	NA 20-22	lm
ES-2835-1072V-L1-P01P	-	Q4 140-150	

(2) Forward Voltage (Tj=25°C)

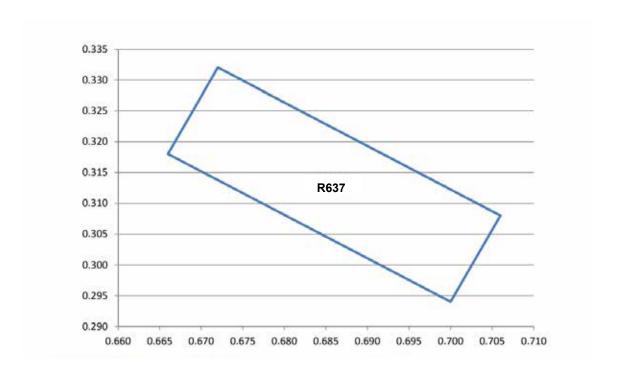
Rank	Condition	Min.	Max.	Unit
J4		64	66	
J5	15mA	66	68	V
J6		68	70	
J7		70	72	
18		72	74	

- 1. 10% tolerance for luminous intensity may be caused by measurement inaccuracy.
- 2. Measurement Uncertainty of the Forward Voltage: ± 3%



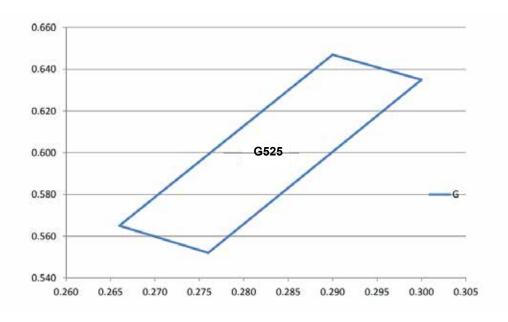
(3) Chromaticity Bins

Rank		ES-2835-1072V-L1-R637				
Bin Code	Color Coordinates (X,Y)					
R637	Х	0.6660	0.6720	0.7060	0.7000	
	Υ	0.3180	0.3320	0.3080	0.2940	

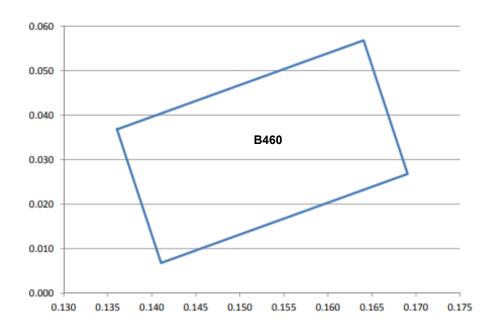




Rank		ES-2835-	1072V-L1-G52	25	
Bin Code		Color Co	ordinates(X,Y	")	
	Х	0.2900	0.2660	0.2760	0.3000
G525					
	Υ	0.6470	0.5650	0.5520	0.6350



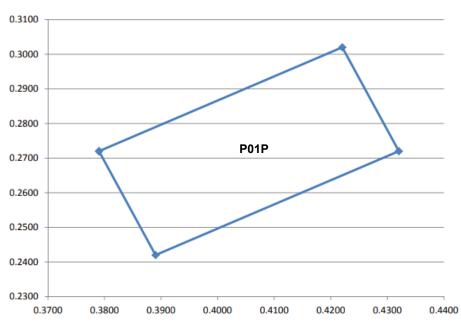
Rank		ES-2835-1072V-L1-B460				
Bin Code	Color Coordinates(X,Y)					
B460	Χ	0.1361	0.1411	0.1691	0.1641	
	Υ	0.0368	0.0068	0.0268	0.0568	





Rank		ES-2835-1072V-L1-P01P				
Bin Code		Color Coordinates(X,Y)				
	Х	0.3790	0.3890	0.4320	0.4220	
PO1P	Υ	0.2720	0.2420	0.2720	0.3020	







REFLOW SOLDERING CHARACTERISTICS

For Reflow Process

Preheating: 140°C~160°C±5°C, within 2 minutes.

Operation heating: 260°C(Max.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).

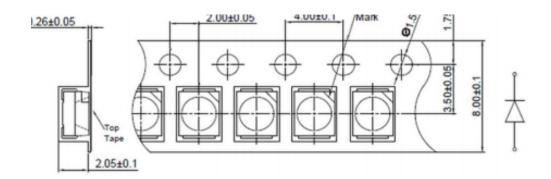
Lead sold	er	Lead-free so	older
Pre-heat	120-150℃	Pre-heat	150-200°C
Pre-heat time	120 sec.Max.	Pre-heat time	120 sec.Max.
Peak Temperature	240℃ Max.	Peak Temperature	260℃ Max.
Soldering time condition	dition 10 sec.Max. Soldering ti		10 sec.Max.
Lead Solder 2.5-5° C / sec. 240 °C Max. 10 sec. Max. 10 sec. Max. Above 200 °C			260 °C Max. 10 sec. Max. ec. Max. ove 220 °C

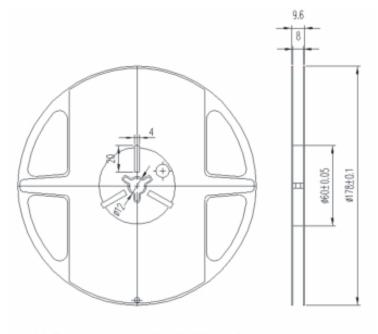
Notes:

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.



TAPE AND REEL



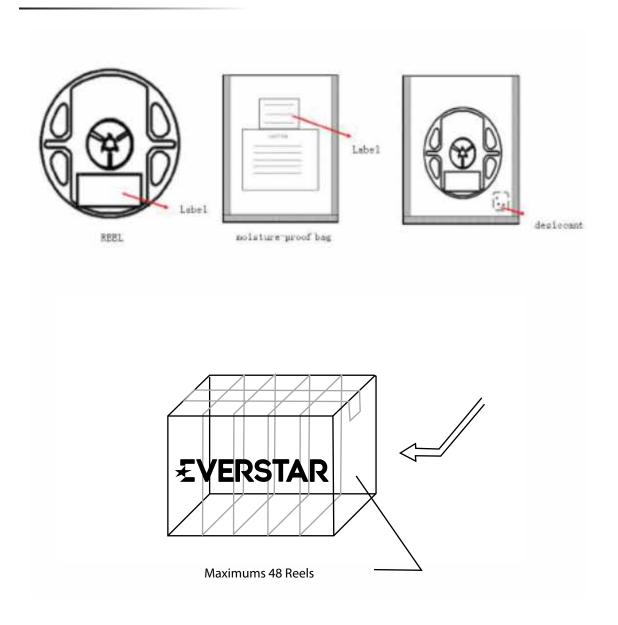


Note: The tolerances unless mentioned is ±0.1mm, Unit=mm

- (1) Quantity: 4,000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the
- carrier tape at the angle of 10° to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.



PACKAGING



RELIABILITY TEST ITEMS

Test Items	Test Duration	Number of Damaged
Steady State Operating Life of High Temperature (HTOL) Ts=85℃, IF=Max	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) Ta=-40°C, IF=Max	1000hrs	0/20
Pulse Wet Operating Life of High Temperature (PWHTOL) 60°C/90%RH, IF30mins ON/30min OFF	500hrs	0/20
High Temperature Storage (HTS) °C 80°C	1000hrs	0/20
Low Temperature Storage (LTS) -40°C	1000hrs	0/20
Thermal Shock (TS) -45°C~125°C 30min dwell 20sec transfer	100cycles	0/20
Solder Resistance (SR) 265℃, 3X MSL	5sec	0/20
Solder Ability (SA) 245°C5sec, 95% coverage	5sec	0/11
Mechanical Shock (MS) 1500G 0.5msec pulse shock	Each6 axis	0/6
Random Vibration (RV) 6G RMS, 10-2000Hz, 10min	Per axis	0/6
Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over	6hrs	0/6
Salt Spread (SS) 35°C, 30g/m2/day	48hrs	0/11

Item	Symbol	Test Condition	Criteria foi Min.	Judgment Max.
Forward Voltage	VF	IF=Typical Current		U.S.L x1.1
Luminous Flux	lm	IF=Typical Current	L.S.L x0.7	
CCX&CCY	x.y	IF=Typical Current		Shift<0.02



PRECAUTION FOR USE

- (1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- (2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3months or more after being shipped from Everstar, a sealed container with a nitrogen atmosphere should be used for storage.
- (4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (5) The appearance and specifications of the product may be modified for improvement without notice.
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.
- (7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LEDs get unlighted at low current.

